

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No.: To Be Assigned  
Applicant: Shigeru Morimoto et al.  
Filed: September 30, 2003  
Title: A PRINTED CIRCUIT BOARD, A BUILDUP SUBSTRATE, A METHOD OF MANUFACTURING PRINTED CIRCUIT BOARD, AND AN ELECTRONIC DEVICE (AS AMENDED)

TC/A.U.: To Be Assigned  
Examiner: To Be Assigned  
Confirmation No.: To Be Assigned  
Docket No.: MTS-3463US

**PRELIMINARY AMENDMENT*****Mail Stop Patent Application***

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Prior to examination, please amend the above-identified application as follows:

- Amendments to the Title** begin on page **2** of this paper.
- Amendments to the Specification** begin on page **3** of this paper.
- Amendments to the Claims** are reflected in the listing of claims which begins on page **9** of this paper.
- Amendments to the Drawings** begin on page \_\_\_\_\_ of this paper and include an attached replacement sheet(s).
- Amendments to the Abstract** are on page **14** of this paper. A clean version of the Abstract is on page **15** of this paper.
- Remarks/Arguments** begin on page \_\_\_\_\_ of this paper.

**Amendments to the Title:**

Please replace the Title with the following:

A PRINTED CIRCUIT BOARD, A BUILDUP SUBSTRATE, A METHOD OF  
MANUFACTURING PRINTED CIRCUIT BOARD, AND AN ELECTRONIC DEVICE